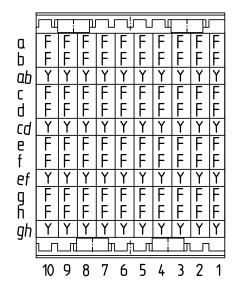


Bestückungsplan – contact layout

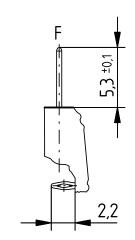


1) Ø0.6 ±0.05 Durchmesser des metallisierten Loches Ø0.6 ±0.05 Diameter of finished plated-through hole

 $\emptyset$ 0.7 ±0.02 Bohrungsdurchmesser des Loches  $\emptyset$ 0.7 ±0.02 Diameter of drilled hole

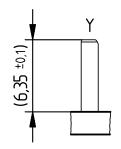
Schichtaufbau im metallisierten Loch siehe Zeichnung 114406

Metal plating of plated-through hole see drawing 114406

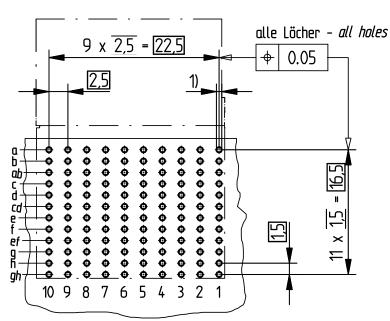


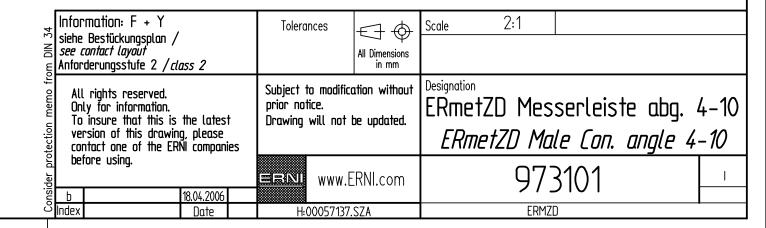
Kontaktversion, Messerkontakt Contact Option, Male Contact

Kontaktversion, Schirmmesser Contact Option, Shielding Contact



Lochbild für Leiterplatte Board hole pattern (Bestückungsseite) (Component mounting side)





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